捷多邦,专业PCB打样ISN54LW245A中SN74LV245AOCTAL BUS TRANSCEIVERSWITH 3-STATE OUTPUTS

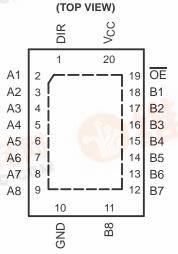
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- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 6.5 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 >2.3 V at V_{CC} = 3.3 V, T_A = 25°C
- Support Mixed-Mode Voltage Operation on All Ports
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

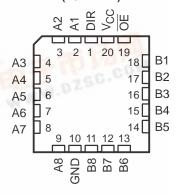
SN54LV245A . . . J OR W PACKAGE SN74LV245A . . . DB, DGV, DW, NS, OR PW PACKAGE



SN74LV245A . . . RGY PACKAGE



SN54LV245A . . . FK PACKAGE (TOP VIEW)



description/ordering information

These octal bus transceivers are designed for 2-V to 5.5-V V_{CC} operation.

ORDERING INFORMATION

| TA | PACKA | GEŤ | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|--------------|--------------------------|---------------------|
| W Land V | QFN – RGY | Reel of 1000 | SN74LV245ARGYR | LV245A |
| 11-1- | 0010 014 | Tube of 25 | SN74LV245ADW | 17/0454 |
| | SOIC - DW | Reel of 2000 | SN74LV245ADWR | LV245A |
| | SOP - NS | Reel of 2000 | SN74LV245ANSR | 74LV245A |
| 4000 1- 0500 | SSOP – DB | Reel of 2000 | SN74LV245ADBR | LV245A |
| −40°C to 85°C | | Tube of 70 | SN74LV245APW | WWW.BL |
| | TSSOP - PW | Reel of 2000 | SN74LV245APWR | LV245A |
| | T | Reel of 250 | SN74LV245APWT | |
| - 14 | TVSOP - DGV | Reel of 2000 | SN74LV245ADGVR | LV245A |
| am cP | VFBGA – GQN | Reel of 1000 | SN74LV245AGQNR | LV245A |
| The said | CDIP – J | Tube of 20 | SNJ54LV245AJ | SNJ54LV245AJ |
| -55°C to 125°C | CFP – W | Tube of 85 | SNJ54LV245AW | SNJ54LV245AW |
| | LCCC – FK | Tube of 55 | SNJ54LV245AFK | SNJ54LV245AFK |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SN54LV245A, SN74LV245A OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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description/ordering information (continued)

The 'LV245A devices are designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

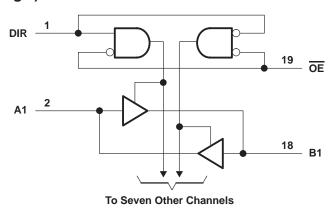
terminal assignments

| | 1 | 2 | 2 3 | |
|---|-----|-----|-----|----|
| Α | A1 | DIR | Vcc | OE |
| В | А3 | B2 | A2 | B1 |
| С | A5 | A4 | B4 | В3 |
| D | A7 | B6 | A6 | B5 |
| Е | GND | A8 | B8 | В7 |

FUNCTION TABLE

| INP | UTS | ODED ATION |
|-----|-----|-----------------|
| OE | DIR | OPERATION |
| L | L | B data to A bus |
| L | Н | A data to B bus |
| Н | Χ | Isolation |

logic diagram (positive logic)



Pin numbers shown are for the DB, DGV, DW, FK, J, NS, PW, RGY, and W packages.



SN54LV245A, SN74LV245A OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | |
|------------------------------------------------------------------------------------------------|---------------------|
| I/O ports (see Notes 1 and 2) | |
| Voltage range applied to any output in the high-impedance or | |
| power-off state, V _O (see Note 1) | |
| Output voltage range applied in the high or low state, V _O (see Notes 1 and 2)0.5 V | to $V_{CC} + 0.5 V$ |
| Input clamp current, I _{IK} (V _I < 0) | –20 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | |
| Continuous current through V _{CC} or GND | |
| Package thermal impedance, θ _{JA} (see Note 3): DB package | |
| (see Note 3): DGV package | 92°C/W |
| (see Note 3): DW package | |
| (see Note 3): GQN package | |
| (see Note 3): NS package | 60°C/W |
| (see Note 3): PW package | |
| (see Note 4): RGY package | |
| Storage temperature range, T _{stq} | |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 5.5 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.
- 4. The package thermal impedance is calculated in accordance with JESD 51-5.

SN54LV245A, SN74LV245A OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCLS382N – SEPTEMBER 1997 – REVISED APRIL 2005

recommended operating conditions (see Note 5)

| | | | SN54L | .V245A | SN74L | V245A | |
|----------------|------------------------------------|--------------------------------------------|----------------------|----------------------|-----------------------|---------------------|------|
| | | | MIN | MAX | MIN | MAX | UNIT |
| Vcc | Supply voltage | | 2 | 5.5 | 2 | 5.5 | V |
| | | V _{CC} = 2 V | 1.5 | | 1.5 | | |
| ١., | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | $V_{CC} \times 0.7$ | | $V_{CC} \times 0.7$ | | ., |
| VIH | High-level input voltage | V _{CC} = 3 V to 3.6 V | V _{CC} ×0.7 | | $V_{CC} \times 0.7$ | | V |
| | | V _{CC} = 4.5 V to 5.5 V | V _{CC} ×0.7 | | V _{CC} × 0.7 | | |
| | | V _{CC} = 2 V | | 0.5 | | 0.5 | |
| V | Law lavel input valtage | V _{CC} = 2.3 V to 2.7 V | | $V_{CC} \times 0.3$ | | $V_{CC} \times 0.3$ | ., |
| VIL | Low-level input voltage | V _{CC} = 3 V to 3.6 V | | $V_{CC} \times 0.3$ | | $V_{CC} \times 0.3$ | V |
| | | V _{CC} = 4.5 V to 5.5 V | | V _{CC} ×0.3 | | $V_{CC} \times 0.3$ | |
| ٧ _I | Input voltage | | 0 | 5.5 | 0 | 5.5 | V |
| ., | Output wells as | High or low state | 0 | ~Vcc | 0 | Vcc | |
| VO | Output voltage | 3-state | 0 , | 5.5 | 0 | 5.5 | V |
| | | V _{CC} = 2 V | 2 | -50 | | -50 | μΑ |
| | High lovel output output | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 20 | -2 | | -2 | |
| ІОН | High-level output current | V _{CC} = 3 V to 3.6 V | Q | -8 | | -8 | mA |
| | | V _{CC} = 4.5 V to 5.5 V | | -16 | | -16 | |
| | | V _{CC} = 2 V | | 50 | | 50 | μΑ |
| ١. | Law law law day day and a company | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2 | | 2 | |
| lor | Low-level output current | V _{CC} = 3 V to 3.6 V | | 8 | | 8 | mA |
| | | V _{CC} = 4.5 V to 5.5 V | | 16 | | 16 | |
| | | V _{CC} = 2.3 V to 2.7 V | | 200 | | 200 | |
| Δt/Δν | Input transition rise or fall rate | V _{CC} = 3 V to 3.6 V | | 100 | | 100 | ns/V |
| | | V _{CC} = 4.5 V to 5.5 V | | 20 | | 20 | |
| TA | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C |

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | DAMETER | TEGT COMPITIONS | ., | SN5 | 4LV245A | | SN74 | ILV245A | 1 | |
|------------------|----------------|----------------------------------|--------------|----------------------|---------|------|----------------------|---------|------|------|
| PA | RAMETER | TEST CONDITIONS | VCC | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| | | I _{OH} = -50 μA | 2 V to 5.5 V | V _{CC} -0.1 | | | V _{CC} -0.1 | | | |
| ١,, | | I _{OH} = -2 mA | 2.3 V | 2 | | | 2 | | | ., |
| VOH | | I _{OH} = -8 mA | 3 V | 2.48 | | | 2.48 | | | V |
| | | I _{OH} = -16 mA | 4.5 V | 3.8 | | | 3.8 | | | |
| | | I _{OL} = 50 μA | 2 V to 5.5 V | | 4 | 0.1 | | | 0.1 | |
| ١,, | | I _{OL} = 2 mA | 2.3 V | | W | 0.4 | | | 0.4 | ., |
| VOL | | I _{OL} = 8 mA | 3 V | 0.44 | | 0.44 | V | | | |
| | | I _{OL} = 16 mA | 4.5 V | | R | 0.55 | | | 0.55 | |
| II | Control inputs | V _I = 5.5 V or GND | 0 to 5.5 V | 3 |) | ±1 | | | ±1 | μΑ |
| loz | A or B port | $V_O = V_{CC}$ or GND | 5.5 V | 20 | | ±5 | | | ±5 | μΑ |
| Icc | • | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | Q | | 20 | | | 20 | μΑ |
| l _{off} | | V_I or $V_O = 0$ to 5.5 V | 0 | | | 5 | | | 5 | μΑ |
| | | V V 0V5 | 3.3 V | | 3 | | | 3 | | _ |
| Ci | Control inputs | $V_I = V_{CC}$ or GND | 5 V | | 3 | | | 3 | | pF |
| <u> </u> | A D | V- V or CND | 3.3 V | | 5.5 | | | 5.5 | | |
| C _{io} | A or B port | $V_O = V_{CC}$ or GND | 5 V | | 5.5 | | | 5.5 | | pF |

switching characteristics over recommended operating free-air V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1) temperature range,

| DADAMETER | FROM | то | LOAD | T, | д = 25°C | ; | SN54L | /245A | SN74LV | /245A | LINUT |
|------------------|---------|----------|------------------------|-----|----------|-------|---------------------------|-------|--------|-------|-------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| ^t pd | A or B | B or A | | | 8.3* | 13* | 1* | 15* | 1 | 15 | |
| t _{en} | OE | A or B | C _L = 15 pF | | 11.8* | 19.9* | 1* | 22* | 1 | 22 | ns |
| ^t dis | ŌE | A or B | | | 11.8* | 18.1* | 1* | 20* | 1 | 20 | |
| ^t pd | A or B | B or A | | | 11.2 | 15.9 | 1/ | 18 | 1 | 18 | |
| t _{en} | OE | A or B | 0 50 5 | | 14.1 | 22.7 | $\gamma_{\gamma_{\zeta}}$ | 26 | 1 | 26 | |
| t _{dis} | ŌĒ | A or B | C _L = 50 pF | | 17.6 | 23.1 | 0 1 | 25 | 1 | 25 | ns |
| tsk(o) | | | | | | 2 | Q | | | 2 | |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1) free-air temperature range,

| | FROM | то | LOAD | LOAD T _A = 25°C | | SN54L | /245A | SN74L | /245A | | |
|--------------------|---------|----------|------------------------|----------------------------|------|-------|-----------------|-------|-------|------|------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| ^t pd | A or B | B or A | | | 5.9* | 8.4* | 1* | 10* | 1 | 10 | |
| t _{en} | ŌĒ | A or B | C _L = 15 pF | | 8.2* | 13.2* | 1* | 15.5* | 1 | 15.5 | ns |
| ^t dis | ŌĒ | A or B | | | 9.6* | 16.5* | 1* | 19.5* | 1 | 19.5 | |
| ^t pd | A or B | B or A | | | 7.9 | 11.9 | 1 | 13.5 | 1 | 13.5 | |
| t _{en} | ŌĒ | A or B | 0 50 5 | | 9.9 | 16.7 | ን _{ሻረ} | 19 | 1 | 19 | |
| ^t dis | ŌĒ | A or B | $C_L = 50 pF$ | | 13.9 | 19.8 | 0 1 | 22 | 1 | 22 | ns |
| t _{sk(o)} | | | | | | 1.5 | Q' | | | 1.5 | |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



SN54LV245A, SN74LV245A OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCLS382N – SEPTEMBER 1997 – REVISED APRIL 2005

switching characteristics over recommended operating V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1) free-air range, temperature

| DADAMETED | FROM | то | LOAD | T, | ղ = 25°C | ; | SN54L | V245A | SN74L | /245A | LINUT |
|------------------|---------|----------|------------------------|-----|----------|-------|-------|-------|-------|-------|-------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| ^t pd | A or B | B or A | | | 4.3* | 5.5* | 1* | 6.5* | 1 | 6.5 | |
| t _{en} | ŌĒ | A or B | C _L = 15 pF | | 5.7* | 8.5* | 1* | 10.6* | 1 | 10 | ns |
| ^t dis | ŌE | A or B | | | 7.8* | 12.8* | 1* | 14.7* | 1 | 14.2 | |
| ^t pd | A or B | B or A | | | 5.6 | 7.5 | 1 | 8.5 | 1 | 8.5 | |
| t _{en} | ŌĒ | A or B | 0 50 5 | | 7 | 10.6 | 77/2 | 12 | 1 | 12 | |
| t _{dis} | ŌĒ | A or B | C _L = 50 pF | | 10.9 | 14.7 | 0 1 | 16 | 1 | 16 | ns |
| tsk(o) | | | | | | 1 | ď | | | 1 | |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3 \text{ V}$, $C_L = 50 \text{ pF}$, $T_A = 25^{\circ}\text{C}$ (see Note 6)

| | DADAMETED | SN | 74LV245 | Α | |
|--------------------|-----------------------------------------------|------|---------|------|------|
| | PARAMETER | MIN | TYP | MAX | UNIT |
| V _{OL(P)} | Quiet output, maximum dynamic VOL | | 0.5 | 0.8 | V |
| V _{OL(V)} | Quiet output, minimum dynamic VOL | | -0.4 | -0.8 | V |
| V _{OH(V)} | Quiet output, minimum dynamic V _{OH} | | 2.9 | | V |
| V _{IH(D)} | High-level dynamic input voltage | 2.31 | | | V |
| V _{IL(D)} | Low-level dynamic input voltage | | | 0.99 | V |

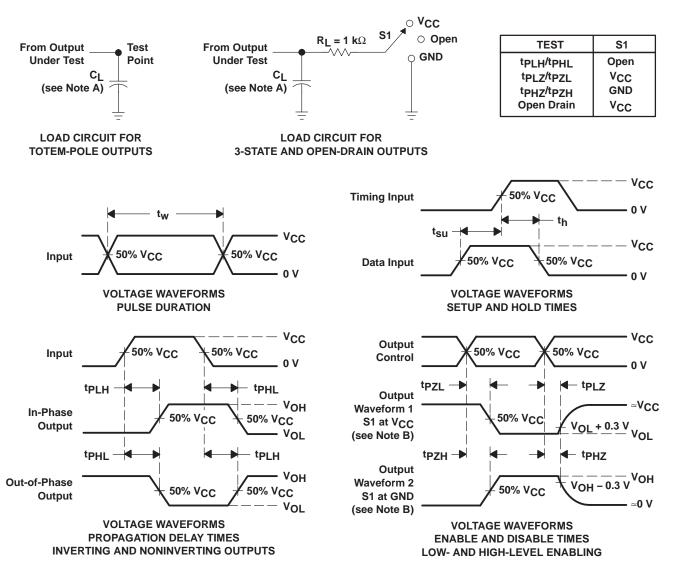
NOTE 6: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^{\circ}C$

| | PARAMETER | | | TEST CONDITIONS | | | UNIT |
|----------|-------------------------------|-----------------|------------------------|-----------------|-------|----|------|
| <u> </u> | Down discination conscitones | Outpute enabled | C. F0 pF | f 10 MH- | 3.3 V | 20 | PΓ |
| Cpd | Power dissipation capacitance | Outputs enabled | $C_L = 50 \text{ pF},$ | f = 10 MHz | 5 V | 25 | рг |



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq$ 3 ns, $t_f \leq$ 3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. t_{PHL} and t_{PLH} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







25-Oct-2005

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp (3) |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|--------------------|
| SN74LV245ADBLE | OBSOLETE | SSOP | DB | 20 | | TBD | Call TI | Call TI |
| SN74LV245ADBR | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADBRE4 | ACTIVE | SSOP | DB | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADGVR | ACTIVE | TVSOP | DGV | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADGVRE4 | ACTIVE | TVSOP | DGV | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADW | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADWE4 | ACTIVE | SOIC | DW | 20 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADWR | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ADWRE4 | ACTIVE | SOIC | DW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245AGQNR | ACTIVE | VFBGA | GQN | 20 | 1000 | TBD | SNPB | Level-1-240C-UNLIM |
| SN74LV245ANSR | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ANSRG4 | ACTIVE | SO | NS | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APW | ACTIVE | TSSOP | PW | 20 | 70 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APWE4 | ACTIVE | TSSOP | PW | 20 | 70 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APWLE | OBSOLETE | TSSOP | PW | 20 | | TBD | Call TI | Call TI |
| SN74LV245APWR | ACTIVE | TSSOP | PW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APWRE4 | ACTIVE | TSSOP | PW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APWRG4 | ACTIVE | TSSOP | PW | 20 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APWT | ACTIVE | TSSOP | PW | 20 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245APWTE4 | ACTIVE | TSSOP | PW | 20 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LV245ARGYR | ACTIVE | QFN | RGY | 20 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74LV245ARGYRG4 | ACTIVE | QFN | RGY | 20 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |
| SN74LV245AZQNR | ACTIVE | VFBGA | ZQN | 20 | 1000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.



PACKAGE OPTION ADDENDUM

25-Oct-2005

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

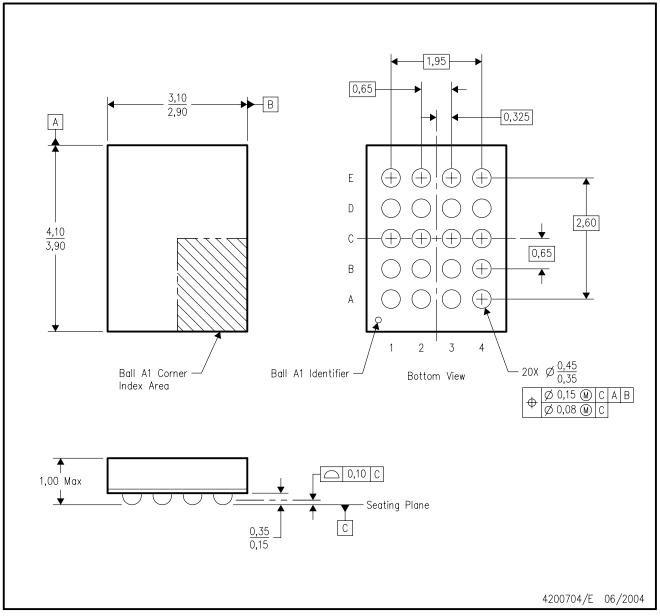
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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GQN (R-PBGA-N20)

PLASTIC BALL GRID ARRAY

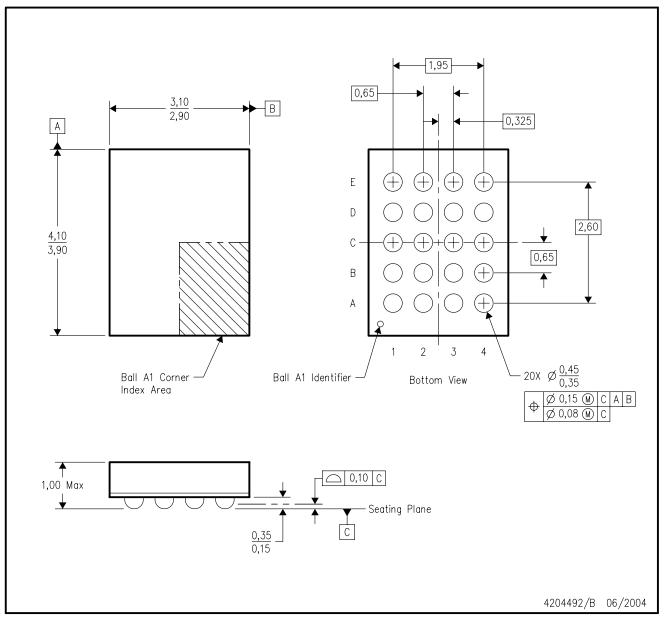


- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BC.
- D. This package is tin-lead (SnPb). Refer to the 20 ZQN package (drawing 4204492) for lead-free.



ZQN (R-PBGA-N20)

PLASTIC BALL GRID ARRAY



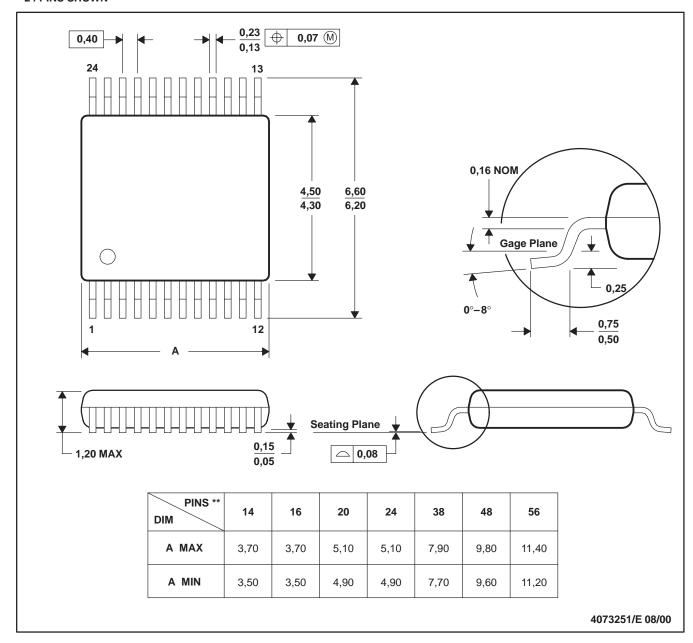
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-225 variation BC.
- D. This package is lead-free. Refer to the 20 GQN package (drawing 4200704) for tin-lead (SnPb).



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



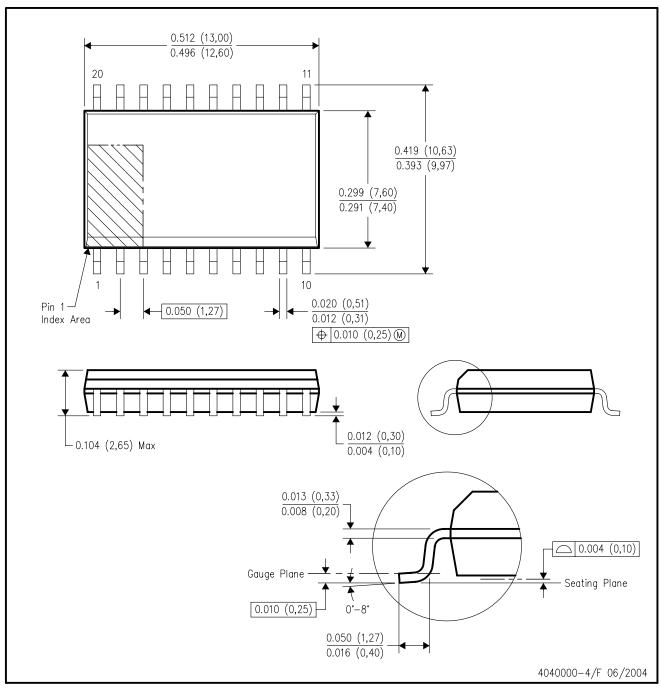
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153 14/16/20/56 Pins – MO-194



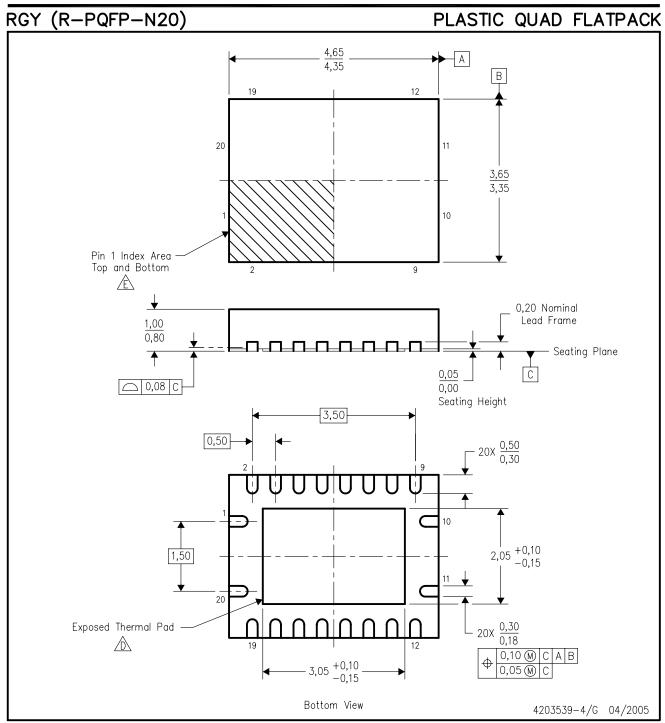
DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.





NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) package configuration.
- The package thermal pad must be soldered to the board for thermal and mechanical performance.
- Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
- F. Package complies to JEDEC MO-241 variation BC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



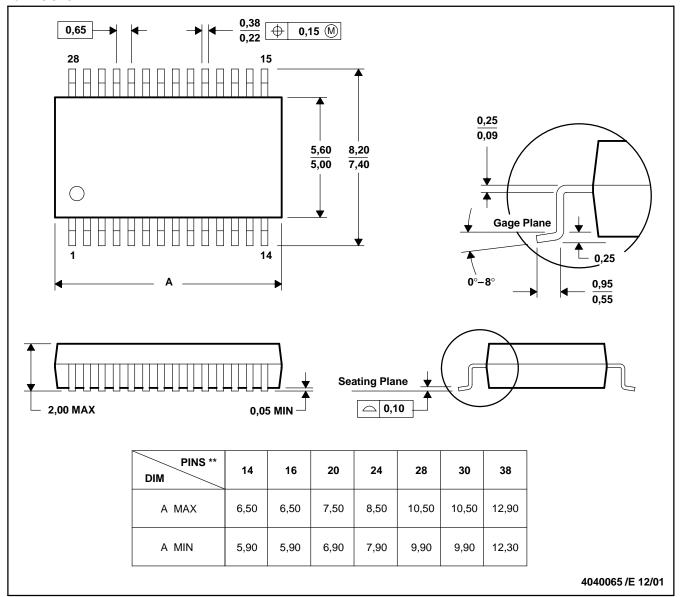
- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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